## **BGA Heat Sink (High Aspect Ratio Ext.)** Straight Fin





ATS024024011-SF-8J ATS Part#:

Description: 24.00 x 24.00 x 11.00 mm BGA Heat Sink (High Aspect Ratio Ext.) Straight Fin

Heat Sink Type: Straight Fin Heat Sink Attachment: superGRIP Equivalent Part Number: N/A

\*Image above is for illustration purpose only.

## **Features & Benefits**

- · High aspect ratio, straight fin heat sinks that are ideal for compact PCB environments
- Features a low profile, slant fin array that offers many of the performance benefits of maxiFLOW™ at a great value
- Higher performance helps ensure reliable product life at a lower cost than other extruded heat sinks
- Comes standard without interface material or with most common pressure sensitive thermal tapes as a custom option

## **Thermal Performance**

AIR VELOCITY		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	10.16 °C/W	6.9 °C/W	5.5 °C/W	4.8 °C/W	4.4 °C/W	4 °C/W	3.7 °C/W
	Ducted Flow	4.7	3.9	3.5	3.2	2.9	2.8	2.6

## **Product Detail**



